

Applications

SmartSMT MIX500D SLOPE solder paste mixer is used to mix the solder paste to a liquid state effectively and evenly to achieve better results in stencil printing and reflowing processes.

Features

- The solder cream jars are placed in 45 angle, and run around its axis line, so the solder cream will not adhere to the jar cover.
- Double security design to assure the safety of operators.
- The air bubbles can be eliminated while the solder paste is being mixed. .
- The control of the solder paste mixing is considered fully with using special control circuit.
- The rotating speed has proved by practice, so the impact against the tin power and the effect to solder paste quality in the rising temperature are avoided.



MIX500D SLOPE

Specifications

Model	MIX500D SLOPE
Power	220V AC (50hz) 60W or 110VAC (60hz) 60W
Rotating Speed	Primary rotating:1000RPM; Second rotating:380RPM
Capacity	500g*2jar
Jar Diameter	Φ60-Φ67mm
Time Setting	0.1~9.9mins, adjust 0.1min per time; 10~30mins, adjust 1.0min per time.
Display & Alarm	LED digital display、light blink and buzzer warning
Machine's Dimension	420*420*427mm(W*D*H)
Packing Dimension	540*540*540mm(W*D*H)
Net/Gross Weight	30KG/45KG